



GP/1746  
Patent  
255/236  
P00-0021  
SAH  
#4A  
2-20-01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

**BERGMAN, Eric J.**

Serial No.: 09/621,028

Filed: July 21, 2000

For: **PROCESS AND APPARATUS FOR  
TREATING A WORKPIECE SUCH AS A  
SEMICONDUCTOR WAFER**

Group Art Unit: ~~Not yet assigned~~ 1746

Examiner: ~~Not yet assigned~~ CARRILLO

PRELIMINARY AMENDMENT

Commissioner for Patents  
Washington, D.C. 20231

Sir:

Before examination, please amend the above-identified application as follows:

In The Specification

Please amend the specification as follows:

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CERTIFICATE OF MAILING  
(37 C.F.R. §1.8a)

I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as First Class Mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

2/9, 2001  
Date of Deposit  
LA-178241.1

Laura Murphy  
Name of Person Mailing Paper  
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